

S4M02600F(LS)

SENSITIVE GATE SILICON CONTROLLED RECTIFIERS REVERSE BLOCKING THYRISTORS

SCRs 4 AMPERES RMS 600 VOLTS

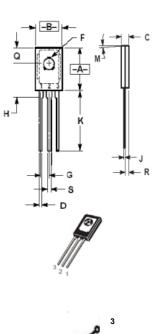
TO-126

FEATURES

- Glass Passivated Junctions for Reliability and Uniformity
- Power Rated Economical Prices
- Practical Level Triggering and Holding Characteristics
- Flat, Rugged, Thermopad Construction for Low Thermal
- Resistance High Heat Dissipation and Durability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

MECHANICAL DATA

- Package: TO-126
- Package Material: Molded Plastic
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.658 grams(Approximate)



T0126 DIM. MIN. MAX 10.16 11.43 В 7.12 8.38 2.29 3.04 С D 0.64 0.88 2.54 3.3 2.54 G 2.04 Н 2.54 0.39 0.63 J K 15.12 16.63 Μ 3° TYP Q 3.31 4 44 R 0.89 1.65 0.64 0.88 All Dimensions in millimeter

		PIN ASSIGNMENT
3	1	Cathode
→ •	2	Anode
	3	Gate

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noticed) **ABSOLUTE RATINGS**

CHARACTERISTICS	SYMBOL	VALUE	UNIT
Peak Repetitive Off-State Voltage (T _J = -40 to 110°C, Sine Wave, 50 to 60Hz; Gate Open)	V _{DRM} V _{RRM}	600	V
On-State RMS Current (180° Conduction Angles, $T_C = 80^{\circ}C$)	I _{T(RMS)}	4	Α
Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave 60Hz, T _J = 25°C)	Ітѕм	25	Α
Circuit Fusing Consideration (t = 8.3ms)	l ² t	2.6	A ² s
Forward Peak Gate Power	Рдм	1	W
Forward Average Gate Power	P _G (AV)	0.1	W
Operating Junction Temperature Range	TJ	-40 to +110	°C
Storage Temperature Range	Tstg	-40 to +150	°C

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. VDRM and VRRM for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



RATING AND CHARACTERISTIC CURVES S4M02600F

THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	VALUE	UNIT	
Thermal Resistance - Junction to Case		7.0	°C/W	
- Junction to Ambient	RthJA	75	C/VV	
Maximum Lead Temperature for Soldering Purposes 1/8 from Case for 10 Seconds	TL	260	°C	

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

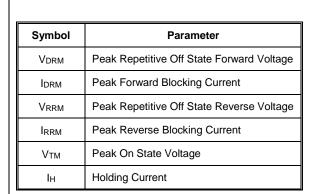
OFF CHARACTERISTICS		SYMBOL	MIN.	TYP.	MAX.	UNIT
Peak Repetitive Forward or Reverse Blocking Current	T _J = 25°C	IDRM			10	
(Vak = Rated V _{DRM} and V _{RRM} ; R _{GK} = 1k Ohms)	T _J = 110°C	IRRM			200	μΑ

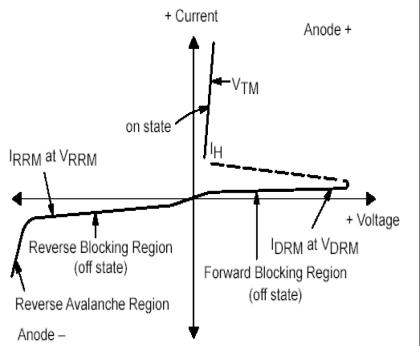
ON CHARACTERISTICS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Peak Forward On-State Voltage (I _{TM} = 8.0A Peak Pulse Width ≤ 1.0ms, Duty Cycle ≤ 1%)	Vтм			2.2	V
Gate Trigger Current (VAK = 12V; RL = 100 Ohms) (1)	lgт			200	μΑ
Holding Current (Vak = 12V; RL = 100 Ohms)	Ін			5.0	mA
Latch Current (V _{AK} = 12V; R _L = 100 Ohms) (1)	IL			10	mA
Gate Trigger Voltage (V _D = 12V; R _L =100 Ohms)	VgT			1.0	V

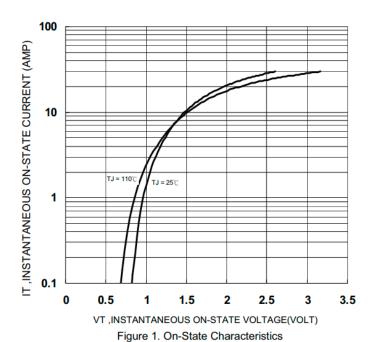
DYNAMIC CHARACTERISTICS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Critical Rate of Rise of Off-State Voltage (VAK = 0.67% Rated VDRM, Exponential Waveform	dv/dt		10		V/µs
$T_J = 110^{\circ}C$, $R_{GK} = 1k$ Ohm,)					·

⁽¹⁾ RGK current is not included in measurement.

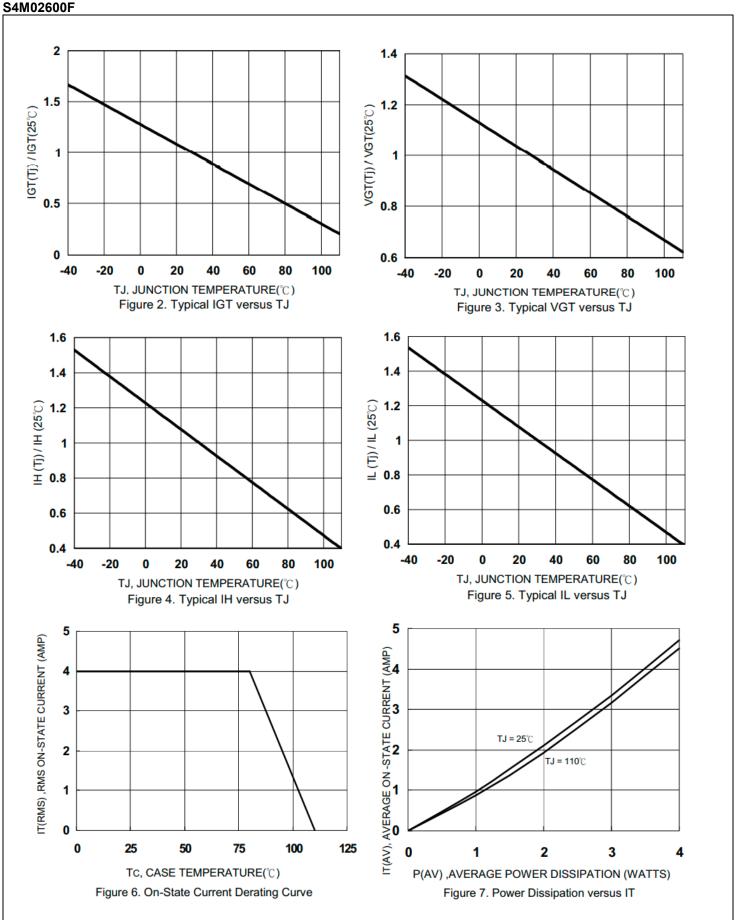
RATING AND CHARACTERISTIC CURVES S4M02600F







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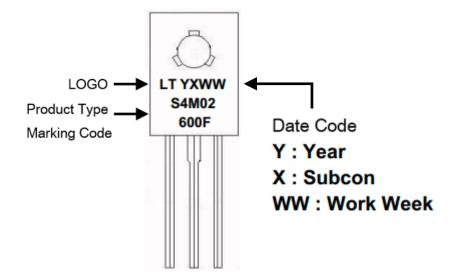




Ordering Information:

Part Number	Packago	Pac	king
Fait Number	Package	Qty.	Carrier
S4M02600F-BU	TO-126	200	Bulk

Marking Information:





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